



**ALPHA & OMEGA**  
SEMICONDUCTOR

**AO4815**  
**30V Dual P-Channel MOSFET**

### General Description

The AO4815 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected.

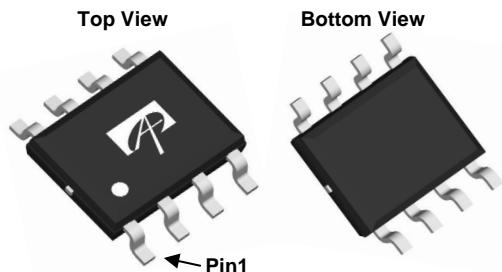
### Product Summary

$V_{DS}$  (V) = -30V  
 $I_D$  = -8A ( $V_{GS}$  = -20V)  
 $R_{DS(ON)} < 18m\Omega$  ( $V_{GS}$  = -20V)  
 $R_{DS(ON)} < 20m\Omega$  ( $V_{GS}$  = -10V)

ESD Rating: 2KV HBM  
100% UIS Tested  
100%  $R_g$  Tested

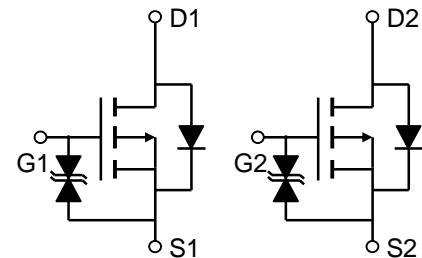


SOIC-8



Top View

S2	1	8	D2
G2	2	7	D2
S1	3	6	D1
G1	4	5	D1



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Continuous Drain Current <sup>A</sup>	$I_D$	-8	A
$T_A=70^\circ C$		-6.9	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	-40	
Power Dissipation <sup>A</sup>	$P_D$	2	W
$T_A=70^\circ C$		1.44	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	50	62.5	°C/W
Steady-State		73	110	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	31	40	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1	$\mu\text{A}$
					-5	
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm25\text{V}$			$\pm1$	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1	-2.8	-3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=-10\text{V}, V_{DS}=-5\text{V}$	-40			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=-20\text{V}, I_D=-8\text{A}$ $T_J=125^\circ\text{C}$		14.1	18	$\text{m}\Omega$
		$V_{GS}=-10\text{V}, I_D=-8\text{A}$		19	24	
		$V_{GS}=-4.5\text{V}, I_D=-5\text{A}$		16.2	20	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-8\text{A}$		37		$\text{m}\Omega$
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$			-1	V
$I_S$	Maximum Body-Diode Continuous Current				-2.6	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		2330	2900	pF
$C_{\text{oss}}$	Output Capacitance			480		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			320		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		6.8	10	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-8\text{A}$		41	52	nC
$Q_{\text{gs}}$	Gate Source Charge			10		nC
$Q_{\text{gd}}$	Gate Drain Charge			12		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.8\Omega, R_{\text{GEN}}=3\Omega$		13		ns
$t_r$	Turn-On Rise Time			12		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			51		ns
$t_f$	Turn-Off Fall Time			30.5		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time	$I_F=-8\text{A}, dI/dt=100\text{A}/\mu\text{s}$		28	35	ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=-8\text{A}, dI/dt=100\text{A}/\mu\text{s}$		20.5		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

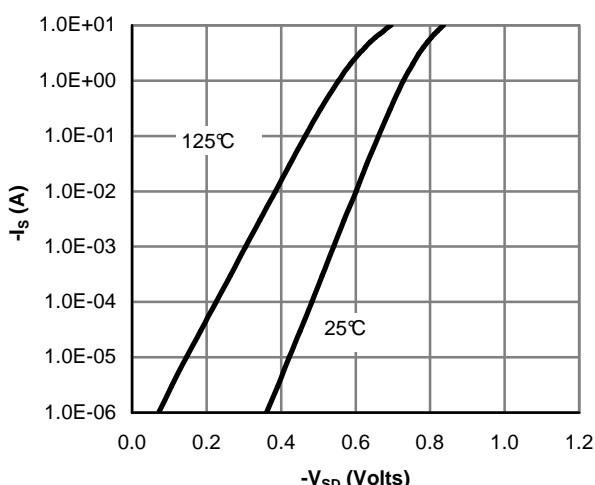
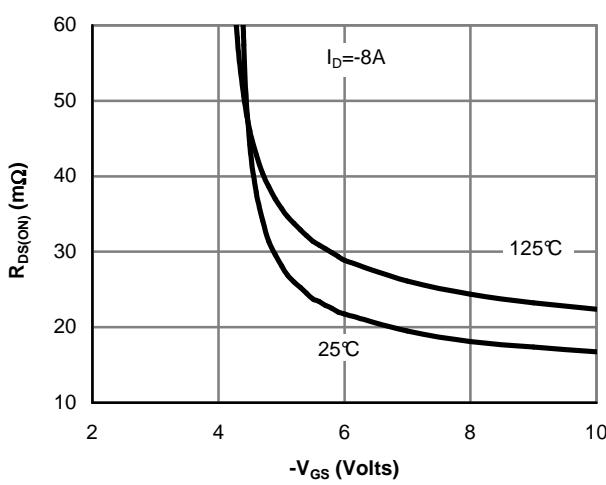
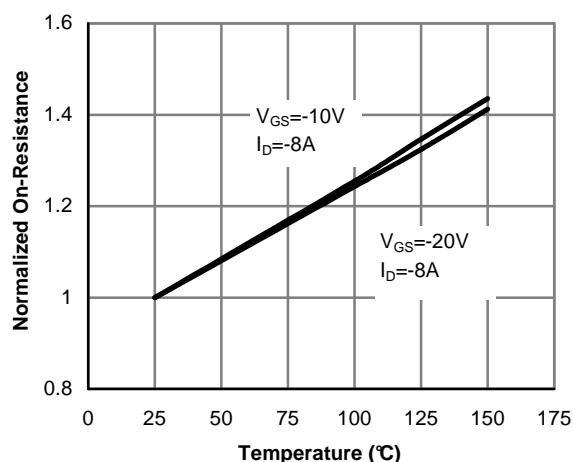
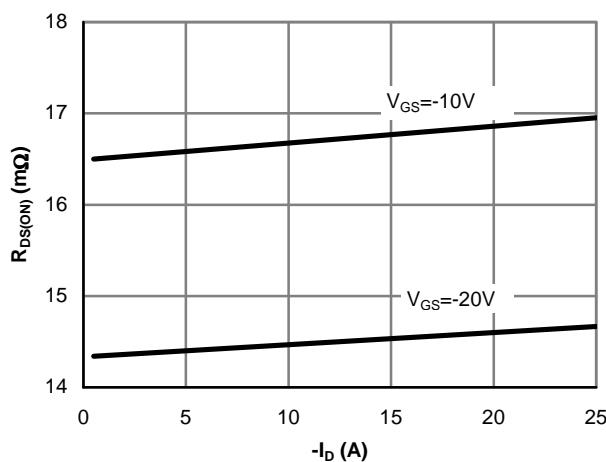
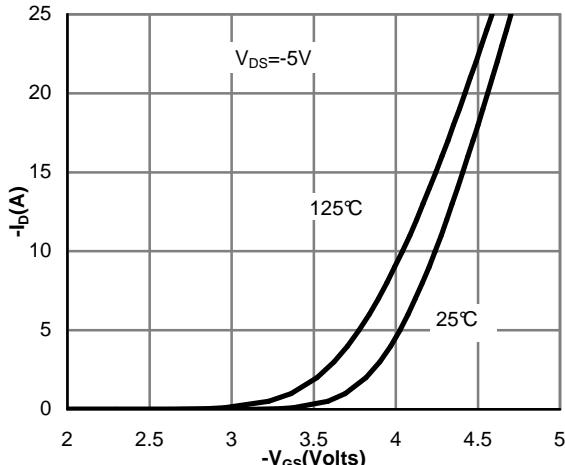
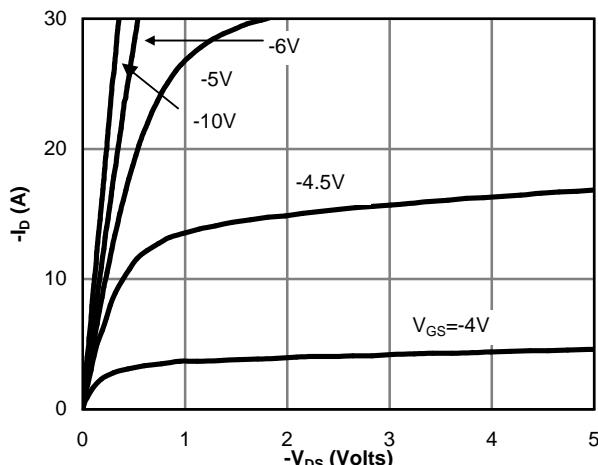
D. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

Rev 4: Nov. 2010

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

